

Low Noise, Low Drift **Single-Supply Operational Amplifiers**

OP113/0P213/0P413

FEATURES

Single- or dual-supply operation Low noise: 4.7 nV/√Hz @ 1 kHz Wide bandwidth: 3.4 MHz Low offset voltage: 100 µV Very low drift: 0.2 μV/°C Unity gain stable No phase reversal

APPLICATIONS

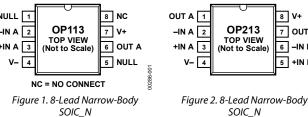
Digital scales Multimedia Strain gages **Battery-powered instrumentation** Temperature transducer amplifier

GENERAL DESCRIPTION

The OPx13 family of single-supply operational amplifiers features both low noise and drift. It has been designed for systems with internal calibration. Often these processor-based systems are capable of calibrating corrections for offset and gain, but they cannot correct for temperature drifts and noise. Optimized for these parameters, the OPx13 family can be used to take advantage of superior analog performance combined with digital correction. Many systems using internal calibration operate from unipolar supplies, usually either 5 V or 12 V. The OPx13 family is designed to operate from single supplies from 4 V to 36 V and to maintain its low noise and precision

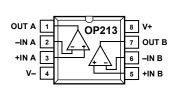
The OPx13 family is unity gain stable and has a typical gain bandwidth product of 3.4 MHz. Slew rate is in excess of 1 V/μs. Noise density is a very low 4.7 nV/ $\sqrt{\text{Hz}}$, and noise in the 0.1 Hz to 10 Hz band is 120 nV p-p. Input offset voltage is guaranteed and offset drift is guaranteed to be less than $0.8 \,\mu\text{V}/^{\circ}\text{C}$. Input common-mode range includes the negative supply and to within 1 V of the positive supply over the full supply range. Phase reversal protection is designed into the OPx13 family for cases where input voltage range is exceeded. Output voltage swings also include the negative supply and go to within 1 V of the positive rail. The output is capable of sinking and sourcing current throughout its range and is specified with 600 Ω loads.

PIN CONFIGURATIONS





SOIC_N



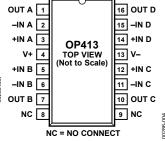


Figure 3. 8-Lead PDIP

Figure 4. 16-Lead Wide-Body SOIC W

Digital scales and other strain gage applications benefit from the very low noise and low drift of the OPx13 family. Other applications include use as a buffer or amplifier for both analogto-digital (ADC) and digital-to-analog (DAC) sigma-delta converters. Often these converters have high resolutions requiring the lowest noise amplifier to utilize their full potential. Many of these converters operate in either singlesupply or low-supply voltage systems, and attaining the greater signal swing possible increases system performance.

The OPx13 family is specified for single 5 V and dual ± 15 V operation over the XIND—extended industrial temperature range (-40°C to +85°C). They are available in PDIP and SOIC surface-mount packages.

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SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

@ $V_s = \pm 15.0$ V, $T_A = 25$ °C, unless otherwise noted.

Table 1.

				E Grade		F Grade			
Parameter	Symbol	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
INPUT CHARACTERISTICS									
Offset Voltage	Vos	OP113			75			150	μV
		-40 °C $\leq T_A \leq +85$ °C			125			225	μV
		OP213			100			250	μV
		-40 °C $\leq T_A \leq +85$ °C			150			325	μV
		OP413			125			275	μV
		-40 °C \leq T _A \leq $+85$ °C			175			350	μV
Input Bias Current	I _B	$V_{CM} = 0 V$		240	600			600	nA
		-40 °C $\leq T_A \leq +85$ °C			700			700	nA
Input Offset Current	los	$V_{CM} = 0 V$							
		-40 °C $\leq T_A \leq +85$ °C			50			50	nA
Input Voltage Range	V _{CM}		-15		+14	-15		+14	V
Common-Mode Rejection	CMR	$-15 \text{ V} \leq \text{V}_{\text{CM}} \leq +14 \text{ V}$	100	116		96			dB
		$-15 \text{ V} \le \text{V}_{\text{CM}} \le +14 \text{ V},$							
		-40 °C $\leq T_A \leq +85$ °C	97	116		94			dB
Large-Signal Voltage Gain	Avo	OP113, OP213,							
		$R_L = 600 \Omega$,							
		-40 °C $\leq T_A \leq +85$ °C	1	2.4		1			V/µV
		OP413, $R_L = 1 \text{ k}\Omega$,							
		$-40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	1	2.4		1			V/µV
		$R_L = 2 k\Omega$,							
		$-40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	2	8		2			V/µV
Long-Term Offset Voltage ¹	Vos				150			300	μV
Offset Voltage Drift ²	$\Delta V_{OS}/\Delta T$			0.2	0.8			1.5	μV/°C
OUTPUT CHARACTERISTICS									
Output Voltage Swing High	V _{OH}	$R_L = 2 k\Omega$	14			14			V
		$R_L = 2 k\Omega$,							
		$-40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	13.9			13.9			V
Output Voltage Swing Low	V _{OL}	$R_L = 2 k\Omega$			-14.5			-14.5	V
		$R_L = 2 k\Omega$,			445			445	.,
		$-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$			-14.5			-14.5	٧.
Short-Circuit Limit	I _{SC}			±40			±40		mA
POWER SUPPLY									
Power Supply Rejection Ratio	PSRR	$V_S = \pm 2 \text{ V to } \pm 18 \text{ V}$	103	120		100			dB
		$V_s = \pm 2 \text{ V to } \pm 18 \text{ V}$	100	122		0.7			l In
Complete Company (A. 196		$-40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	100	120		97			dB
Supply Current/Amplifier	I _{SY}	$V_{OUT} = 0 \text{ V, } R_L = \infty,$			2			2	
		$V_S = \pm 18 \text{ V}$			3			3	mA
Consulta Valta da Danasa	.,	$-40^{\circ}\text{C} \le \text{T}_{A} \le +85^{\circ}\text{C}$			3.8	,		3.8	mA
Supply Voltage Range	Vs		4		±18	4		±18	V

				E Grade	;	F Grade			
Parameter	Symbol	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
AUDIO PERFORMANCE									
THD + Noise		$V_{IN} = 3 \text{ V rms}, R_L = 2 \text{ k}\Omega,$							
		f = 1 kHz		0.0009			0.0009		%
Voltage Noise Density	en	f = 10 Hz		9			9		nV/√Hz
		f = 1 kHz		4.7			4.7		nV/√Hz
Current Noise Density	İn	f = 1 kHz		0.4			0.4		pA/√Hz
Voltage Noise	e _n p-p	0.1 Hz to 10 Hz		120			120		nV p-p
DYNAMIC PERFORMANCE									
Slew Rate	SR	$R_L = 2 k\Omega$	0.8	1.2		0.8	1.2		V/µs
Gain Bandwidth Product	GBP			3.4			3.4		MHz
Channel Separation		V _{OUT} = 10 V p-p							
		$R_L = 2 k\Omega$, $f = 1 kHz$		105			105		dB
Settling Time	ts	to 0.01%, 0 V to 10 V step		9			9		μs

¹ Long-term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at 125°C, with an LTPD of 1.3. ² Guaranteed specifications, based on characterization data.

@ $V_S = 5.0 \text{ V}$, $T_A = 25$ °C, unless otherwise noted.

Table 2.

			E Grade		F Grade				
Parameter	Symbol	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
INPUT CHARACTERISTICS									
Offset Voltage	Vos	OP113			125			175	μV
		-40 °C \leq T _A \leq $+85$ °C			175			250	μV
		OP213			150			300	μV
		-40 °C \leq T _A \leq $+85$ °C			225			375	μV
		OP413			175			325	μV
		-40 °C \leq T _A \leq $+85$ °C			250			400	μV
Input Bias Current	I _B	$V_{CM} = 0 \text{ V, } V_{OUT} = 2$		300	650			650	nA
		-40 °C \leq T _A \leq $+85$ °C			750			750	nA
Input Offset Current	los	$V_{CM} = 0 \text{ V, } V_{OUT} = 2$							
		-40 °C \leq T _A \leq $+85$ °C			50			50	nA
Input Voltage Range	V _{CM}		0		4			4	V
Common-Mode Rejection	CMR	$0 \text{ V} \leq V_{CM} \leq 4 \text{ V}$	93	106		90			dB
		$0 \text{ V} \leq V_{CM} \leq 4 \text{ V},$							
		-40 °C \leq T _A \leq $+85$ °C	90			87			dB
Large-Signal Voltage Gain	Avo	OP113, OP213,							
		$R_L = 600 \Omega$, 2 k Ω ,							
		$0.01 \text{ V} \le \text{V}_{\text{OUT}} \le 3.9 \text{ V}$	2			2			V/µV
		OP413, $R_L = 600$, 2 kΩ,							
		$0.01 \text{ V} \le \text{V}_{\text{OUT}} \le 3.9 \text{ V}$	1			1			V/µV
Long-Term Offset Voltage ¹	Vos				200			350	μV
Offset Voltage Drift ²	$\Delta V_{OS}/\Delta T$			0.2	1.0			1.5	μV/°C

				E Grade	e	F Grade			
Parameter	Symbol	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
OUTPUT CHARACTERISTICS									
Output Voltage Swing High	V _{OH}	$R_L = 600 \text{ k}\Omega$	4.0			4.0			V
		$R_L = 100 \text{ k}\Omega$,							
		-40 °C \leq T _A \leq $+85$ °C	4.1			4.1			V
		$R_L = 600 \Omega$,							
		-40 °C \leq T _A \leq $+85$ °C	3.9			3.9			V
Output Voltage Swing Low	V _{OL}	$R_L = 600 \Omega$,							
		-40 °C \leq T _A \leq $+85$ °C			8			8	mV
		$R_L = 100 \text{ k}\Omega$,							
		-40 °C \leq T _A \leq $+85$ °C		8			8		mV
Short-Circuit Limit	I _{SC}			±30			±30		mA
POWER SUPPLY									
Supply Current	I _{SY}	V _{OUT} = 2.0 V, no load		1.6	2.7			2.7	mA
	I _{SY}	-40 °C $\leq T_A \leq +85$ °C			3.0			3.0	mA
AUDIO PERFORMANCE									
THD + Noise		$V_{OUT} = 0 dBu, f = 1 kHz$		0.001			0.001		%
Voltage Noise Density	e _n	f = 10 Hz		9			9		nV/√Hz
		f = 1 kHz		4.7			4.7		nV/√Hz
Current Noise Density	in	f = 1 kHz		0.45			0.45		pA/√Hz
Voltage Noise	e _n p-p	0.1 Hz to 10 Hz		120			120		nV p-p
DYNAMIC PERFORMANCE									
Slew Rate	SR	$R_L = 2 k\Omega$	0.6	0.9		0.6			V/µs
Gain Bandwidth Product	GBP			3.5			3.5		MHz
Settling Time	ts	to 0.01%, 2 V step		5.8			5.8		μs

 $^{^1}$ Long-term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at 125°C, with an LTPD of 1.3. 2 Guaranteed specifications, based on characterization data.

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	±18 V
Input Voltage	±18 V
Differential Input Voltage	±10 V
Output Short-Circuit Duration to GND	Indefinite
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	−65°C to +150°C
Lead Temperature Range (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 4. Thermal Resistance

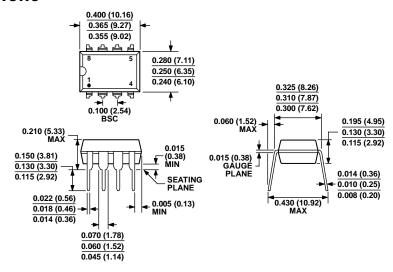
Package Type	θJA	θις	Unit
8-Lead PDIP (P)	103	43	°C/W
8-Lead SOIC_N (S)	158	43	°C/W
16-Lead SOIC_W (S)	92	27	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

OUTLINE DIMENSIONS

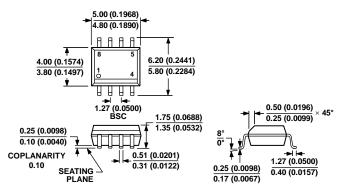


COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 53. 8-Lead Plastic Dual In-Line Package [PDIP]
Narrow Body
P-Suffix
(N-8)

Dimensions shown in inches and (millimeters)



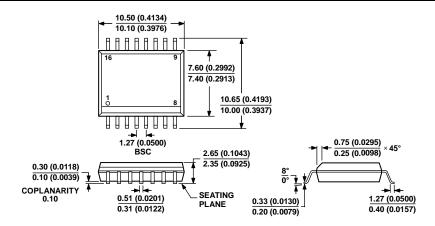
COMPLIANT TO JEDEC STANDARDS MS-012-AA

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 54. 8-Lead Standard Small Outline Package [SOIC_N] Narrow Body S-Suffix (R-8)

Dimensions shown in millimeters and (inches)

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COMPLIANT TO JEDEC STANDARDS MS-013-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 55. 16-Lead Standard Small Outline Package [SOIC_W] Wide Body S-Suffix (RW-16) Dimensions shown in millimeters and (inches)

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Options
OP113ES	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113ES-REEL	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113ES-REEL7	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113ESZ ¹	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113ESZ-REEL ¹	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113ESZ-REEL7 ¹	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FS	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FS-REEL	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FS-REEL7	−40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FSZ ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FSZ-REEL ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP113FSZ-REEL7 ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ES	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ES-REEL	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ES-REEL7	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ESZ ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ESZ-REEL ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213ESZ-REEL7 ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FP	-40°C to +85°C	8-Lead PDIP	N-8 (P-Suffix)
OP213FPZ ¹	-40°C to +85°C	8-Lead PDIP	N-8 (P-Suffix)
OP213FS	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FS-REEL	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FS-REEL7	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FSZ ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FSZ-REEL ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)
OP213FSZ-REEL7 ¹	-40°C to +85°C	8-Lead SOIC_N	R-8 (S-Suffix)